

Structured Silicon Anode

The present invention relates to structured silicon anodes for lithium battery applications.

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Silicon is recognised as a potentially high energy per unit volume host material for lithium in lithium battery applications¹. Attempts at realising this potential have met with only partial success when nano-composites of silicon powder and carbon black have been used². The major technical problem associated with the use of silicon/lithium appears to be the mechanical failure brought about by the repeated large volume expansion associated with alloying^{1c,3}. Metallic and intermetallic anodic host materials, other than layer materials such as graphite, are reported to disintegrate after a few lithium insertion/extraction cycles^{3,4} unless in fine powder form (sub-micron range). Since we are interested in finding a way to make a lithium battery integrated onto a silicon chip we need to find a solution to this materials problem. It is envisaged that the principal applications area for lithium batteries integrated into a chip would be in the medical field. Thus the well-developed practice of cochlea implants appears to be an area that would benefit from an integrated battery supply⁵.

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This invention seeks to realise the potential of the

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silicon-lithium system to allow the possibility of a lithium battery integrated on to a silicon chip.

Accordingly this invention provides a method of
5 fabricating sub-micron silicon electrode structures on a silicon wafer. Preferably these structures comprise pillars.

For a silicon-lithium system the basic cell diagram can be represented as $\text{Li}|\text{Li}^+\text{-electrolyte}|\text{Si}$, for this cell the
10 cathodic process is, discharge of lithium onto silicon to form an alloy (charging), and the anodic process is lithium extraction or de-alloying (discharging). The EMF data reported by Wen and Huggins⁶ for the liquid system at 415°C is shown bracketed below and the solid system at room
15 temperature⁷ is shown un-bracketed below. Their results (in mV vs, Li) are: $\text{Si}/\text{Li}_{12}\text{Si}_7$ -582(332); $\text{Li}_{12}\text{Si}_7/\text{Li}_7\text{Si}_3$ -520(288); $\text{Li}_7\text{Si}_3/\text{Li}_{13}\text{Si}_4$ -428(158); $\text{Li}_{13}\text{Si}_4/\text{Li}_{21}\text{Si}_5$ ~300(44).

It will be appreciated that the formation of $\text{Li}_{12}\text{Si}_7$ in
20 place of Si results in a significant volume change (the alloy is 2.17 times bigger). On a conventional silicon wafer suitable for use as an anode for a lithium battery this volume change leads to crack formation and pulverisation however due to their small size and configuration sub-micron
25 anode structures made in accordance with the invention, are be able to tolerate the conditions occasioned by the massive volume changes occasioned by lithium alloying/de-alloying.

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In tests structured electrodes of sub micron diameter Si pillars maintained their structural integrity throughout the cycling whereas planar Si electrodes showed cracks (2 micron features) after 50 cycles. An appropriate size restriction to achieve suitable electrodes is that the silicon pillars should not exceed a fractional surface coverage (F) of ~0.5.

An embodiment of the invention will now be described by way of non-limiting example only, with reference to the accompanying drawings, in which:

Figure 1 is a schematic view of a structured electrode;

Figure 2 shows one of a series of CV scan sets;

Figure 3 shows results for a series of galvanostatic measurements;

Figure 4 shows pictures of the structure;

figure 5 shows SEM pictures of the structure; and

Figure 6 shows a lithium battery in accordance with the present invention.

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The electrochemical discharge of lithium on silicon and its subsequent chemical reaction destroys the silicon lattice, giving rise to the swelling of the solid, producing amorphous Si/Li phases¹³. The first new phase to appear in

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the system is $\text{Li}_{12}\text{Si}_7$. This compound, and all the rest up to Li, is a so-called Zintl-Phase Compound (ZPC), and consists of simple, electropositive, cations and complex co-valently bound, multiply charged, electronegative, anions. Of course
 5 the charge ascribed to the "ions" is purely notional: the actual charge (depending upon definition) is less than the formal value and may be considerably less, hence the bulk lithium will be referred to as Li° and bulk silicon as Si_n° .

It is important to form some idea of the mechanism of
 10 lithiation and de-lithiation of silicon. It is proposed that:

(i) Discharged lithium reacts with silicon forming a ZPC film with atomically continuous contact to the silicon.

(ii) Lithium excess diffuses (via a vacancy mechanism)
 15 through the compact ZPC film to react with silicon at the Si/ZPC interface, thickening the ZPC film, without void formation.

These processes might be represented by: $\text{Li}^+(\text{el}) + \text{e}^- (\text{solid}) \rightarrow \text{Li}(\text{ads.})$; $\text{Li}(\text{ads.}) + \text{V}(\text{ZPC}) \rightarrow \text{Li}^\circ (\text{ZPC})_s$; $\text{Li}^\circ (\text{ZPC})_s$
 20 $\rightarrow \text{diffusion} \rightarrow \text{Li}^\circ (\text{ZPC})_{\text{ZPC/Si}}$; $x \text{Li}^\circ + y \text{Si}^\circ \rightarrow \text{ZPC} (\text{Li}_{x/y}\text{Si})$.

(Li(ads) is Li adsorbed on ZPC; V is a Li° vacancy in ZPC)

(iii) The amorphous¹³ ZPC film is deformable and so does not give rise to significant stress induced cracking on volume change.

25 The diffusion coefficient, D, for Li in crystalline Si^{14} is $\sim 10^{-14} \text{cm}^2 \text{s}^{-1}$, Li in ZPC is expected to be faster; a value of D

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10⁻¹²cm²s⁻¹ would be enough to account for all the processes carried out in this study. This model for ZPC film formation is in many ways analogous to the model of SiO₂ layer formation on silicon due to Deal and Grove¹⁵: but the details are different and will be treated elsewhere.

The model for ZPC decomposition is, in broad terms, the reverse of the above steps. Discharge of Li⁰ at the electrolyte interface produces a surface vacancy in the ZPC. Locally Li⁰ moves into the vacancy so the vacancy diffuses back to the ZPC/Si interface: at the interface Si_n rejoins the Si phase (where it is said to be polycrystalline¹³) and vacancies coalesce to produce larger void spaces. These spaces, as they coalesce further and grow, give rise to the crack like features seen in the SEM pictures in Figures 4c,d and 5. Such a process has been described by Beaulieu et al¹⁶ for lithium removal from silicon/tin alloys.

It has been shown that repeated Li alloying/de-alloying of planar Si can be carried out without pulverisation of the substrate, cf. Fig. 5. However, as noted, the alloy/de-alloy process is limited by diffusion through the ZPC layer. In order to obtain charging rates suitable for various applications it is necessary to increase the surface area of the Si/electrolyte interface; and this has been done using pillar fabrication. Previous attempts using silicon particles have failed because the particle-to-particle contacts change and part with cycling². The pillar structures, on the other hand, are largely maintained as evidenced by the flatness of the pillar tops after 50 cycles, cf. Fig. 4.

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Efficiencies of <100% reported here are attributed mainly to reaction, on alloying, with the electrolyte, and to a lesser extent isolation of regions of ZPC. The data presented here show that reduced current density on both
5 alloying and de-alloying results in improving efficiency. It is supposed that this improvement comes mainly from a reduced surface concentration of adsorbed Li on alloying and accessing all the lithium in the ZPC on de-alloying.

There is large scope for further increasing the
10 surface-to-volume ratio of the pillar construction, for example, pillars of diameter (d) ~0.3 microns and 6 micron height (H). The pillar volume (v) would be, FH , and for $F=0.4$, $v=2.4 \times 10^{-4}$ cc/cm², which is equivalent, when converted to $\text{Li}_{12}\text{Si}_7$, to a capacity of $3.81 \times 10^3 v = 914 \text{ microAhrcm}^{-2}$. The
15 surface area of such a pillar structure is $\sim 4FH/d$, which is the basis of the much improved characteristics.

To make structures in accordance with the invention the following method may be used, namely "Island
20 Lithography" as disclosed in international patent No. WO01/13414. This method employs cesium chloride as the resist in the lithographic step in the fabrication of pillar arrays. It works as follows. A thin film of CsCl is vacuum deposited on the clean, hydrophilic, surface of the Si
25 substrate. This system is then exposed to the atmosphere at a controlled relative humidity. A multilayer of water adsorbes on the surface, the CsCl is soluble in the water layer (being more soluble at places of higher radius of curvature). The CsCl re-organises into a distribution of

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hemispherical islands, driven by the excess surface energy associated with CsCl surface curvature. Such arrays are useful in making structures for various studies involving nano-scale phenomena. In this case reactive ion etching is preferably used, with the islands acting as X masks so that removal of the surrounding silicon forms the desired pillar structures.

A study of the kinetics of the formation of island arrays has been carried out on GaAs surfaces⁹ and more recently, and more extensively, on Si/SiO₂ surfaces¹⁰ where the technique and results are described in detail. The process variables are: CsCl film thickness (L); humidity (RH), time of exposure (t). The resulting island array has a Gaussian distribution of diameters, average diameter ($\langle d \rangle$) standard deviation ($\pm s$) and surface fractional coverage (F). Having made the CsCl resist array the next step is reactive ion etching (RIE) to produce the corresponding array of pillars¹¹. The RIE process variables are: feed-gas composition, flow rate and chamber pressure; RF power; dc bias; etch time. The results are characterised by the etch depth, corresponding to pillar height (H), and the wall angle, namely the angle that the pillar wall makes with the wafer plane; it is chosen in this study to be close to 90°. The examples reported in this work were etched in a Oxford Plasmalab 80 apparatus. The etch gas was (O₂:Ar: CHF₃) in the ratio 1:10:20; feed rate 20sccm; chamber pressure, 50 milli pascals; RF power, 73 watts; dc bias 200V.

The pillar structure reported in this study (K-series) was characterised as $\langle d \rangle = 580\text{nm} \pm 15\text{nm}$; $F = 0.34$; $H = 810\text{nm}$: it was made using, $L = 80\text{nm}$; $RH = 40\%$; $t = 17.5\text{hrs}$. After

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fabrication the silicon samples were washed in water; etched for 20 seconds in $\text{NH}_4\text{OH}(28\text{w}\% \text{NH}_3):\text{H}_2\text{O}_2(100\text{v/v}):\text{H}_2\text{O}$ in equal volume ratios; the etchant was flooded away with de-ionized water and blow dried.

- 5 Of course the structures may also be fabricated by other known techniques, such as photolithography, which produce regular arrays of features rather than the scattered distribution produced by island lithography.

10 Figure 1 is a schematic view of a structured electrode, in accordance with the invention and as used in the following tests, it shows a part sectional view of the anode in which the pillars 2 can clearly be seen on the silicon wafer 3.

Figure 6 shows a lithium battery, comprising a typical embodiment of the present invention, and including an anode
15 1, a cathode 4, a polymer electrolyte 5, a first strip 6 representing a rectifier circuit connected to a coil encircling the anode for charging purposes, a second strip 7 representing the output circuit (driven by the battery), and a pair of wires 8 for connection to the device to be
20 driven.

Electrochemical tests were performed in a three-electrode, glass, cell where the Si sample is the working electrode and metallic Li is used for both the counter and reference electrodes. A 1 M solution of LiClO_4 (Merck Selectipurâ) in ethylene carbonate:diethyl carbonate (Merck Selectipurâ), (1:1) w/w solvent was used as the electrolyte.
25 The cell was assembled under a dry argon atmosphere in a glove box. Ohmic contact was made to the rear side of the silicon samples electrodes using a 1:1 In-Ga eutectic

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alloy¹². The electrode area was delineated using an O-ring configuration in a PTFE holder. No adhesive is used and a good electrolyte/atmosphere seal is obtained. In an earlier study we found that epoxy adhesive, used to mount a Si
5 electrode, contaminated the active electrode surface causing spurious currents at high voltages ($>2V$).

Electrochemical behaviour of the cell was investigated by cyclic voltammetry (CV) and by galvanostatic measurement (voltage vs. time at constant current), using an
10 electrochemical workstation (VMP PerkinElmer™ Instruments). The capacity referred to here is the total charge inserted into the projected electrode surface area exposed to the electrolyte (this ignores any surface area due to structuring), given as mAhcm^{-2} (micro Amp hours cm^{-2}).

15 The results obtained were:

The response of the $\text{Li}|\text{Li}^+\text{-electrolyte}|\text{Si}$ cell was measured: for this cell the cathodic process is, discharge of lithium onto silicon to form an alloy (charging), and the anodic process is lithium extraction or de-alloying
20 (discharging). Figure 2 shows one series of CV scan sets (details in caption). The first cycle, and to quite a large extent the second, differs from those that follow. It is conjectured that this difference is due to a "formation" effect, associated with the filming of the electrode during
25 the first Li discharge. After the first and second cycles, the scans assume a repeatable general shape. Since these are scans in which the potential is changed slowly and the current densities are therefore small, there are no IR drop or diffusion overpotential terms, and assuming no activation

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overpotential, the electrode potential is a measure of the surface lithium activity. The first cathodic feature is the rapid increase in current at ~330 mV that, according to room temperature data⁷, corresponds to the presence of $\text{Li}_{12}\text{Si}_7$.

5 The lowest potential reached is 25mV and this is taken to be associated with the presence of higher Li compounds, e.g. $\text{Li}_{21}\text{Si}_5$. The cycling sequence shows a progressive "activation" of the sample, associated with increasing breakdown of the crystalline silicon structure (see

10 discussion). The anodic, part of the CV curve is associated with progressive de-lithiation of the electrode according to the various ZPC equilibrium potentials. For a scan rate of 1 mVs^{-1} the capacity (260mAhcm^{-2}) of the electrodes is roughly comparable to the pillar volume being

15 converted to $\text{Li}_{12}\text{Si}_7$, while for the slower scan rates the capacity exceeds that of the pillar volume. The latter results point to the participation of the substrate in the alloying/de-alloying process.

Figure 3 shows the results for a series of galvanostatic

20 measurements on structured Si at two different charge/discharge current densities (details in caption).

Figure 4 shows the structure of the K-series of silicon electrodes that were used in this study and the effects of extensive galvanostatic cycling upon that structure. The

25 structure are clearly intact, but at the higher current density slight cracking of the bulk Si surface, below the pillars, is observed.

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Figure 5 shows the SEM pictures of the structures obtained on planar (un-pillared) Si electrodes before cycling and, separately, after galvanostatic cycling. When cycled at the lower current densities, the surface is deformed, though
5 crack formation does not occur. Cycling at higher current densities produces wide cracks.

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